EXHIBIT 1

ARM® CoreTile Express A15×2 A7×3

Cortex®-A15_A7 MPCore (V2P-CA15_A7)

Technical Reference Manual

ARM®

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ARM CoreTile Express A15×2 A7×3
Technical Reference Manual

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Release Information

The following changes have been made to this book.

Change history

Date	Issue	Confidentiality	Change
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About this book

This book is for the CoreTile Express A15×2 A7×3 daughterboard.

Intended audience

This document is written for experienced hardware and software developers to aid the development of ARM-based products using the CoreTile Express A15×2 A7×3 daughterboard with the Motherboard Express µATX as part of a development system.

Using this book

This book is organized into the following chapters:

Chapter 1 *Introduction*

Read this for an introduction to the CoreTile Express A15×2 A7×3 daughterboard.

Chapter 2 *Hardware Description*

Read this for a description of the hardware present on the daughterboard.

Chapter 3 *Programmers Model*

Read this for a description of the configuration registers present on the daughterboard.

Appendix A *Signal Descriptions*

Read this for a description of the signals present on the daughterboard.

Appendix B *HDLCD controller*

Read this for a description of the HDLCD controller in the Cortex-A15_A7 test chip.

Appendix C *Electrical Specifications*

Read this for a description of the electrical specifications of the daughterboard.

Appendix D *Revisions*

Read this for a description of the technical changes between released issues of this book.

Glossary

The *ARM Glossary* is a list of terms used in ARM documentation, together with definitions for those terms. The *ARM Glossary* does not contain terms that are industry standard unless the ARM meaning differs from the generally accepted meaning.

See *ARM Glossary*, `http://infocenter.arm.com/help/topic/com.arm.doc.aeg0014-/index.html`.

Conventions

This book uses the conventions that are described in:

- *Typographical conventions* on page ix
- *Timing diagrams* on page ix
- *Signals* on page x.

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Chapter 1
Introduction

This chapter provides an introduction to the CoreTile Express A15×2 A7×3 daughterboard. It contains the following sections:

- *About the CoreTile Express A15×2 A7×3 daughterboard* on page 1-2
- *Precautions* on page 1-4.

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1.1 About the CoreTile Express A15×2 A7×3 daughterboard

The CoreTile Express A15×2 A7×3 daughterboard is designed as a platform for developing systems based on *Advanced Microcontroller Bus Architecture* (AMBA) that use the *Advanced eXtensible Interface* (AXI) or custom logic for use with ARM cores.

You can use the CoreTile Express A15×2 A7×3 daughterboard to create prototype systems.

Note

You can use the CoreTile Express A15×2 A7×3 daughterboard with a Motherboard Express µATX See *System interconnect signals* on page 2-6 for information about interconnection.

You can also use the CoreTile Express daughterboard with a custom-design motherboard. See *ARM® Programmer Module (V2M-CP1)*.

The daughterboard includes the following features:

- Cortex-A15_A7 MPCore test chip, with NEON™, that is, the advanced *Single Instruction Multiple Data* (SIMD) extension, and *Floating Point Unit* (FPU), that contains a dual-core A15 cluster operating at 1GHz and a triple-core A7 cluster operating at 800MHz.
- Cortex-A15_A7 MPCore test chip internal AXI subsystem operating at 500MHz.
- Simple configuration with V2M-P1 motherboard:
  - Configuration EEPROM.
  - Daughterboard Configuration Controller.
- Nine programmable oscillators.
- 2GB of daughterboard DDR2 32-bit memory operating at 400MHz.
- *High Definition LCD* (HDLCD) controller that supports up to 1920×1080p video at 60Hz, 165MHz pixel clock.
- CoreSight software debug and 32-bit trace ports.
- HDRX header with one multiplexed AMBA AXI master bus port that connects to the other daughterboard site on the V2M-P1 motherboard.
- HDRY header with four buses to the motherboard:
  - *Static Memory Bus* (SMB).
  - *MultiMedia Bus* (MMB).
  - *Configuration Bus* (CB).
  - *System Bus* (SB).
- *Power Supply Units* (PSUs) for the Cortex-A15_A7 test chip and DDR2 memory.
- Core voltage control and current, temperature, and power monitoring.
- On-board energy meter.

Note

The Cortex-A15_A7 test chip does not support TrustZone®.

Figure 1-1 on page 1-3 shows the layout of the daughterboard:

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2.2 Cortex-A15_A7 MPCore test chip

Figure 2-2 shows the main components of the test chip.

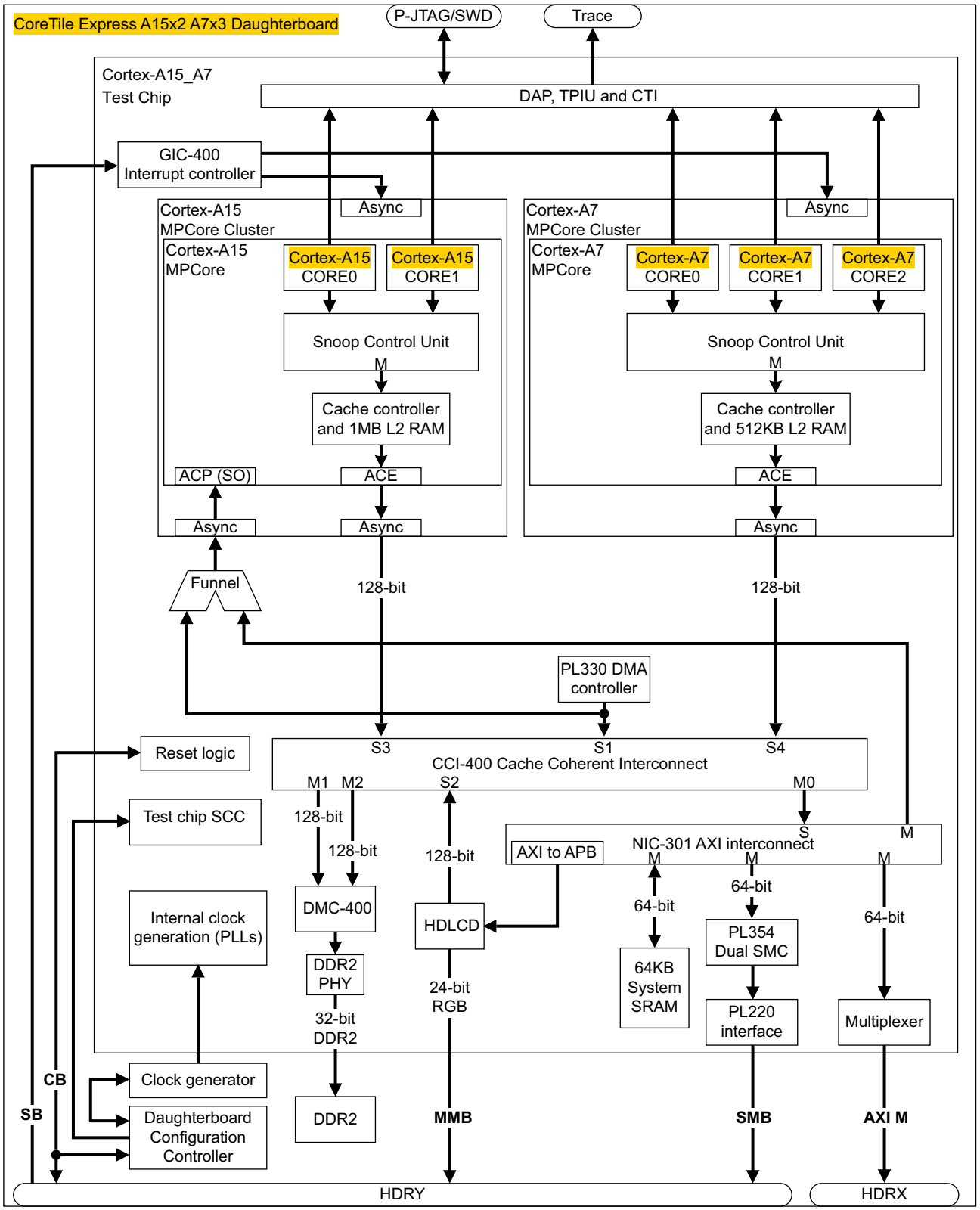

Figure 2-2 Top-level view of the Cortex-A15_A7 MPCore test chip components

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Note

Bus lines with single-headed arrows indicate the direction of control, not the direction of data flow. That is, each arrow points from bus master to bus slave.

Cortex-A15_A7 MPCore test chip

The test chip includes the following components and interfaces:

- Cortex-A15 dual-core cluster operating at 1GHz:
  - Version r2p1.
  - 32KB I/D cache.
  - NEON and *Floating Point Unit* (FPU).
  - ACP port.
  - 1MB L2 cache.
  - Dual *Program Flow Trace Macrocell* (PTM).
- Cortex-A7 triple-core cluster operating at 800MHz:
  - Version r0p1.
  - 32KB I/D cache.
  - NEON and FPU.
  - 512KB L2 cache.
  - Dual *Embedded Trace Macrocell* (ETM).
- NIC-301 AXI interconnect operating at 500MHz.
- CCI-400 cache coherent interconnect operating at 500MHz that provides cache-coherency between the two clusters.
- DMC-400 32-bit *Double Data Rate* 2 (DDR2) *Dynamic Memory Controller* (DMC) interface to the onboard 2GB DDR2 memory.
- PL354 32-bit SMB controller (SMC). This connects to the motherboard peripherals.
- PL330 *Direct Memory Access* (DMA) controller.
- 24-bit HDLCD video controller that drives the MMB to the MUXFPGA on the V2M-P1 Motherboard Express.
- Multiplexed 64-bit AXI master interface.
- 64KB of local on-chip SRAM.
- CoreSight debug and trace interface to the onboard connectors:
  - PTM for each Cortex-A15 core.
  - ETM for each Cortex-A7 core.
  - 16KB ETB.
  - DAP.
  - *Trace Port Interface Unit* (TPIU) for real-time trace data.
  - JTAG interface for debug.
- *Serial Configuration Controller* (SCC) interface:
  - Interfaces to the Daughterboard Configuration Controller.
  - Configures the test chip *Phase-Locked Loops* (PLLs) during power up or reset.
- Interrupts interface:
  - Connects interrupt signals from the V2M-P1 motherboard to the *Generic Interrupt Controller* (GIC) in the test chip.

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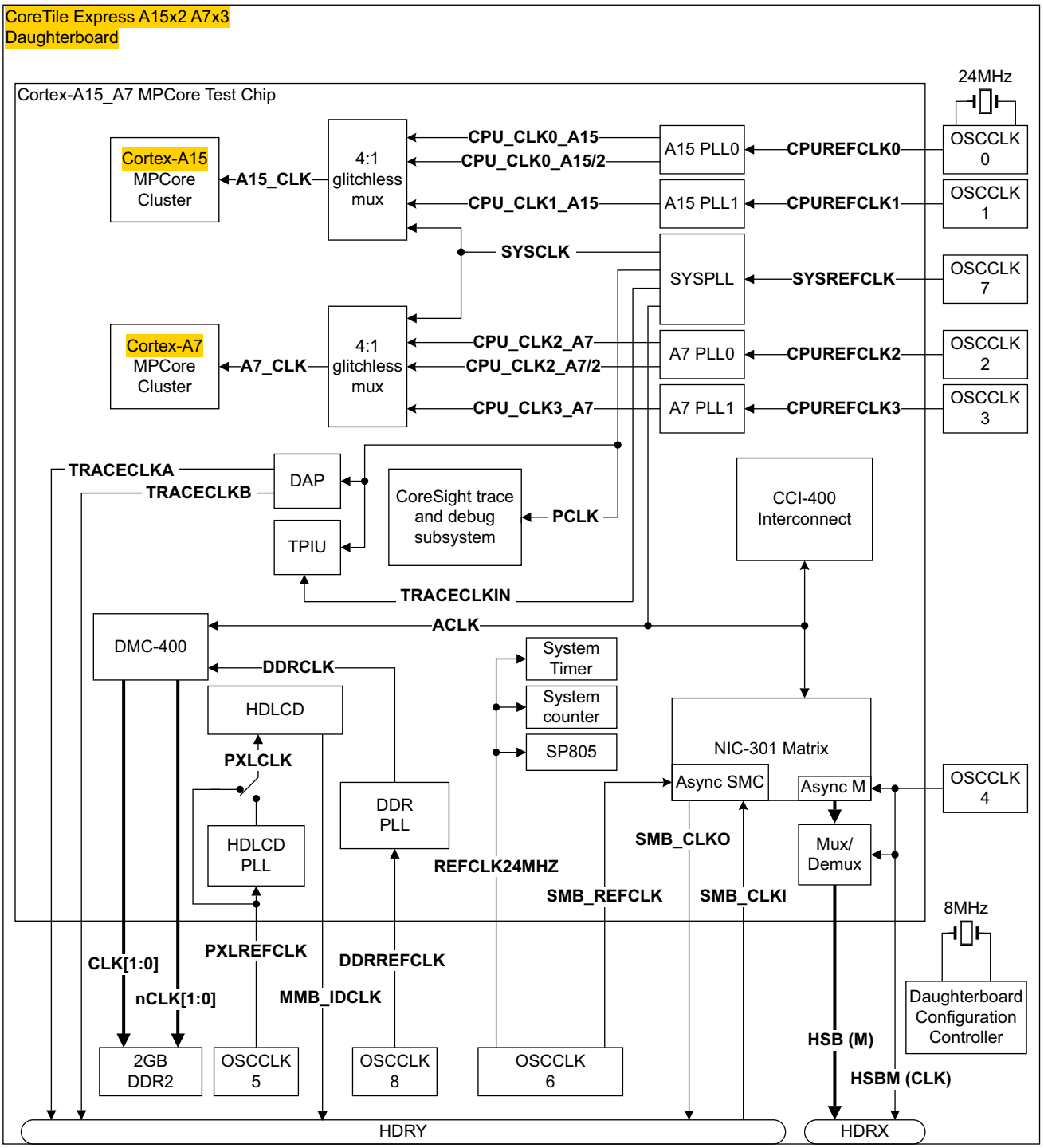

Figure 2-10 CoreTile Express A15×2 A7×3 daughterboard clocks

Figure 2-10 shows the default inputs for the PLLs. You can independently select **SYSREFCLK** as the inputs to any or all of:

- A15 PLL0.
- A15 PLL1.
- A7 PLL0.
- A7 PLL1.
- HDLCD PLL.

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- DDR PLL.

See *Test chip SCC Register 11* on page 3-27.

CPU_CLK0_A15 is the default source for **A15_CLK**.

CPU_CLK2_A7 is the default source for **A7_CLK**.

You can use the 4-way glitchless multiplexers to select any of the four inputs as the sources for **A15_CLK** and **A7_CLK**. See *Test chip SCC Register 11* on page 3-27.

When you write to the SCC registers to change the sources for the MPCore clocks, you can monitor when the change takes effect by reading the clock status register. See *Test chip SCC Register 12* on page 3-30.

You can select the polarity of **MMB_IDCLK** relative to **PXLREFCLK**. It can be either in phase with **PXLREFCLK** or inverted. See *Polarities Register bit assignments* on page B-17.

You can also use the SCC registers to exercise other options, for example, to select *External Bypass* to bypass the PLL and drive the reference clock into the design.

Note

The configuration process bypasses the HDLCD PLL by default.

ARM does not recommend that you select non-default options for the other PLLs and Figure 2-10 on page 2-26 does not show these options. See *Test chip SCC Register 11* on page 3-27 and *Test chip SCC Registers 13, 15, 17, 19, 23, and 25 PLL control registers* on page 3-31.

The MCC and Daughterboard Configuration Controller use the `board.txt` configuration file for the daughterboard to set the frequency of the daughterboard clock generators and to configure the SCC registers on power-up or reset. You can also adjust the daughterboard clocks during run-time by using the motherboard SYS_CFG register interface.

For more information see:

- *Power-up configuration and resets* on page 2-10.
- *Versatile™ Express Configuration Technical Reference Manual* for an example `board.txt` file.
- *Motherboard Express µATX Technical Reference Manual*.

2.7.2 Daughterboard programmable clock generators

This section describes the daughterboard clock generators and the clocks that the test chip generates from them to drive the on-chip systems.

The following SCC registers control the PLLs, clock divider blocks and PLL input select multiplexers:

- *Test chip SCC Register 11* on page 3-27
- *Test chip SCC Register 12* on page 3-30
- *Test chip SCC Registers 13, 15, 17, 19, 23, and 25 PLL control registers* on page 3-31
- *Test chip SCC Registers 14, 16, 18, 22, 24 and 26 PLL value registers* on page 3-33.

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